



EMIF10-LCD02F3

10-line IPAD™, EMI filter and ESD protection for LCD and cameras

Features

- Lead-free package
- EMI symmetrical (I/O) low-pass filter
- High efficiency in EMI filtering
- 400 µm pitch
- Compatible with high speed data rate
- Very low PCB space occupation: < 4mm²
- Very thin package: 0.60 mm
- High efficiency in ESD suppression
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging

Complies with the following standards

- IEC61000-4-2 level 4 on inputs and outputs
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- MIL STD 883E - Method 3015-6 Class 3

Applications

Where EMI filtering in ESD sensitive equipment is required :

- LCD for mobile phones
- Computers and printers
- Communication systems
- MCU boards

Description

The EMIF10-LCD02F3 is a 10-line highly integrated device designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interference. The EMIF10 Flip Chip packaging means the package size is equal to the die size.

This filter includes ESD protection circuitry, which prevents damage to the protected device when subjected to ESD surges up to 15kV.

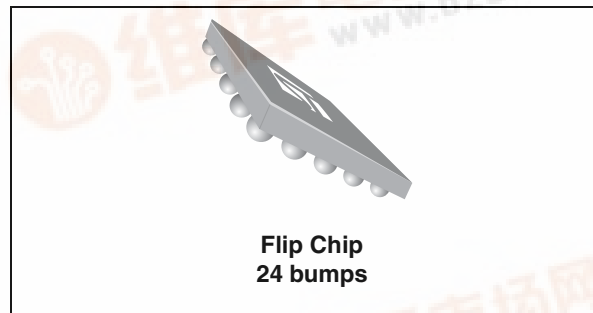


Figure 1. Pin layout (bump side)

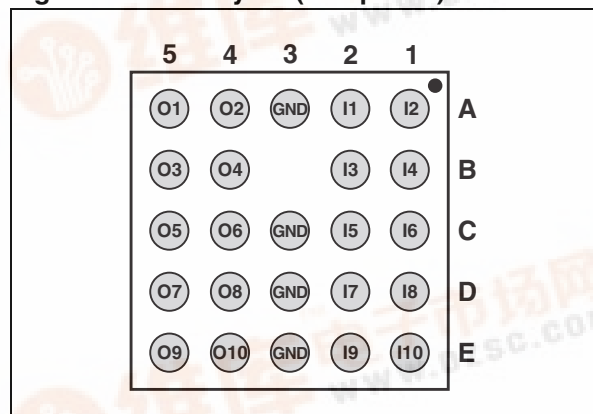
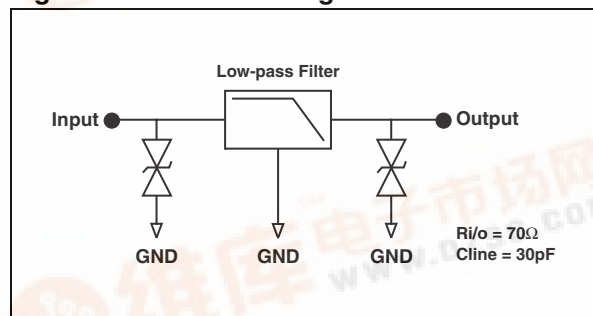


Figure 2. Device configuration



TM: IPAD is a trademark of STMicroelectronics.



1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ °C}$)

Symbol	Parameter and test conditions	Value	Unit
T_j	Maximum junction temperature	125	°C
T_{op}	Operating temperature range	-40 to +85	°C
T_{stg}	Storage temperature range	-55 to 150	°C

Table 2. Electrical characteristics ($T_{amb} = 25\text{ °C}$)

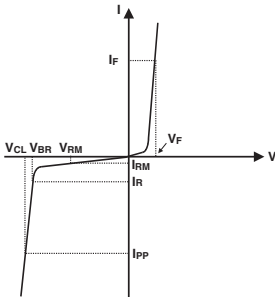
Symbol	Parameters				
V_{BR}	Breakdown voltage				
I_{RM}	Leakage current @ V_{RM}				
V_{RM}	Stand-off voltage				
V_{CL}	Clamping voltage				
I_{PP}	Peak pulse current				
$R_{I/O}$	Series resistance between Input & Output				
C_{line}	Input capacitance per line				
Symbol	Test conditions	Min	Typ	Max	Unit
V_{BR}	$I_R = 1\text{ mA}$	6	8	10	V
I_{RM}	$V_{RM} = 3\text{ V}$		50	200	nA
R_2	Tolerance $\pm 20\%$		70		Ω
C_{line}	$V_{line} = 0\text{ V}$, $V_{OSC} = 30\text{ mV}$, $F = 1\text{ MHz}$			30	pF

Figure 3. S21(dB) all lines attenuation measurement and Aplac simulation

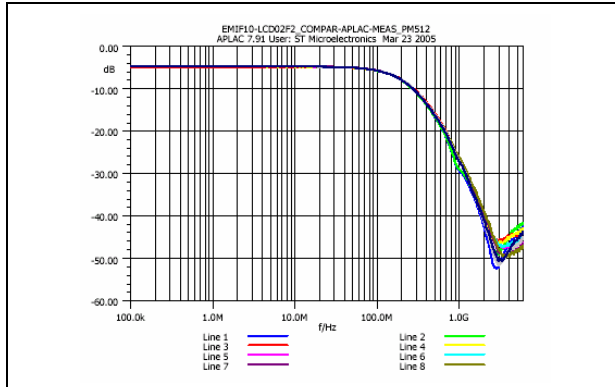


Figure 4. Analog cross talk measurement

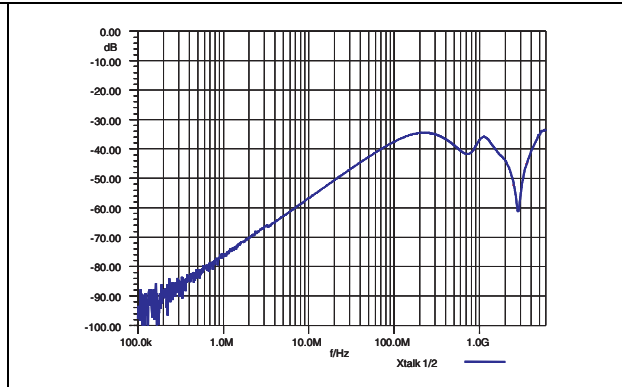


Figure 5. ESD response to IEC 61000-4-2 (+15 kV air discharge) on one input and on one output

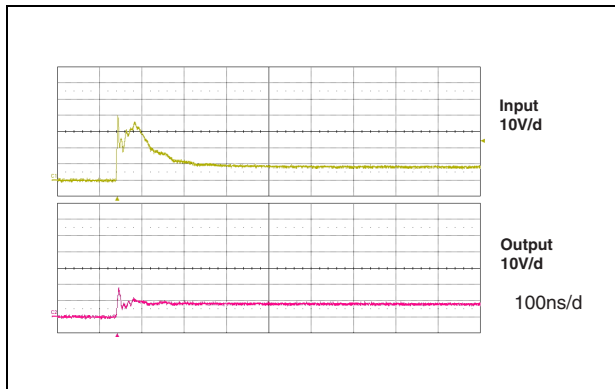


Figure 6. ESD response to IEC 61000-4-2 (-15 kV air discharge) on one input and on one output

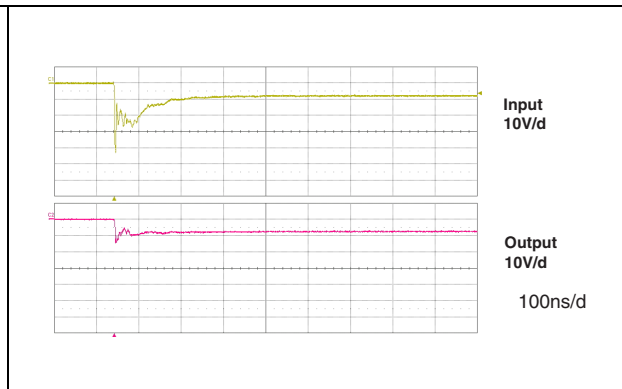
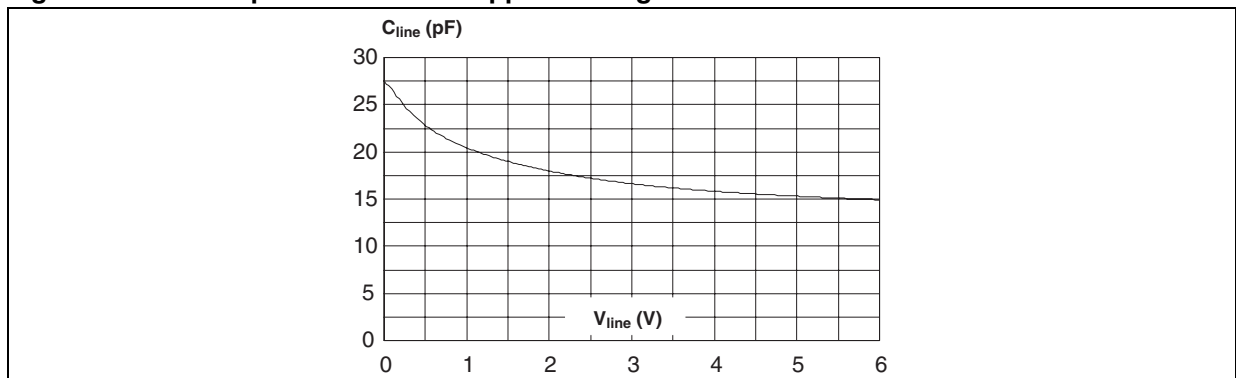


Figure 7. Line capacitance versus applied voltage



2 Application information

Figure 8. Device structure (one cell)

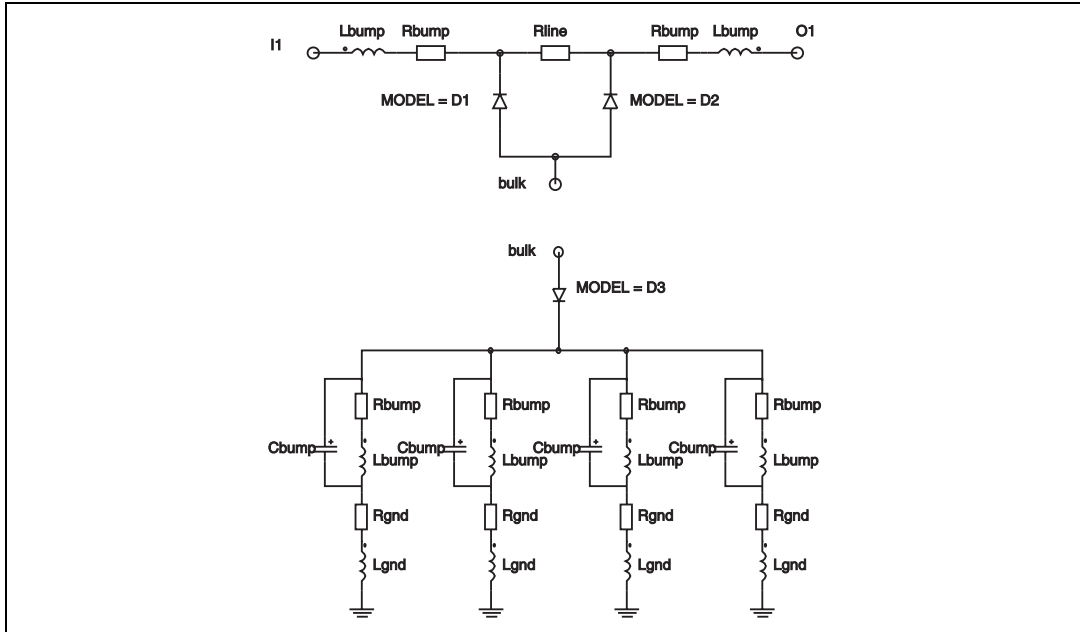
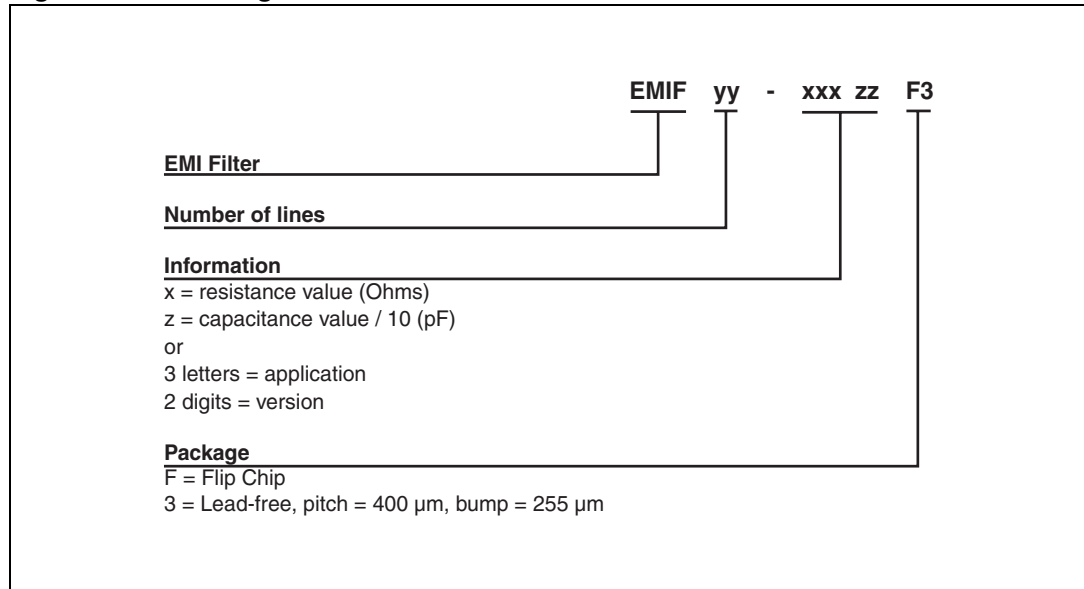


Figure 9. Apla model variables

apla var Rline 70	Diode D1	Diode D2	Diode D3
apla var C_d1 15p	BV=7	BV=7	BV=7
apla var C_d2 15p	IBV=1m	IBV=1m	IBV=1m
apla var C_d3 600p	CJO=C_d1	CJO=C_d2	CJO=C_d3
apla var Ls 950pH	M=0.28	M=0.28	M=0.28
apla var Rs 150m	RS=0.1	RS=0.1	RS=0.01
apla var Lbump 50pH	VJ=0.6	VJ=0.6	VJ=0.6
apla var Rbump 20m	TT=100n	TT=100n	TT=100n
apla var Cbump 150f			
apla var Lgnd 50pH			
apla var Rgnd 100m			
apla var Rsub 10m			

3 Ordering information scheme

Figure 10. Ordering information scheme



4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at www.st.com.

Figure 11. Package dimensions

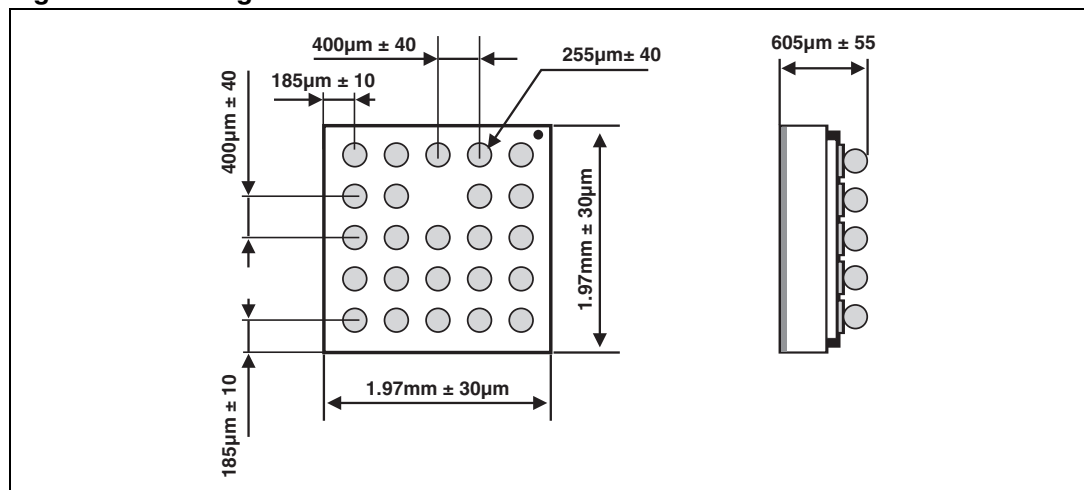


Figure 12. Footprint

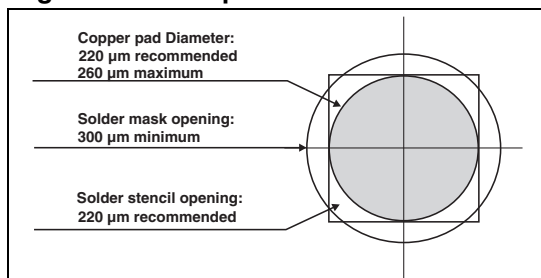


Figure 13. Marking

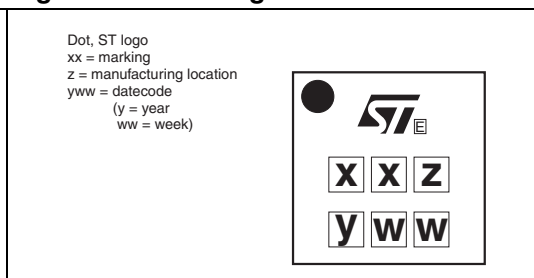
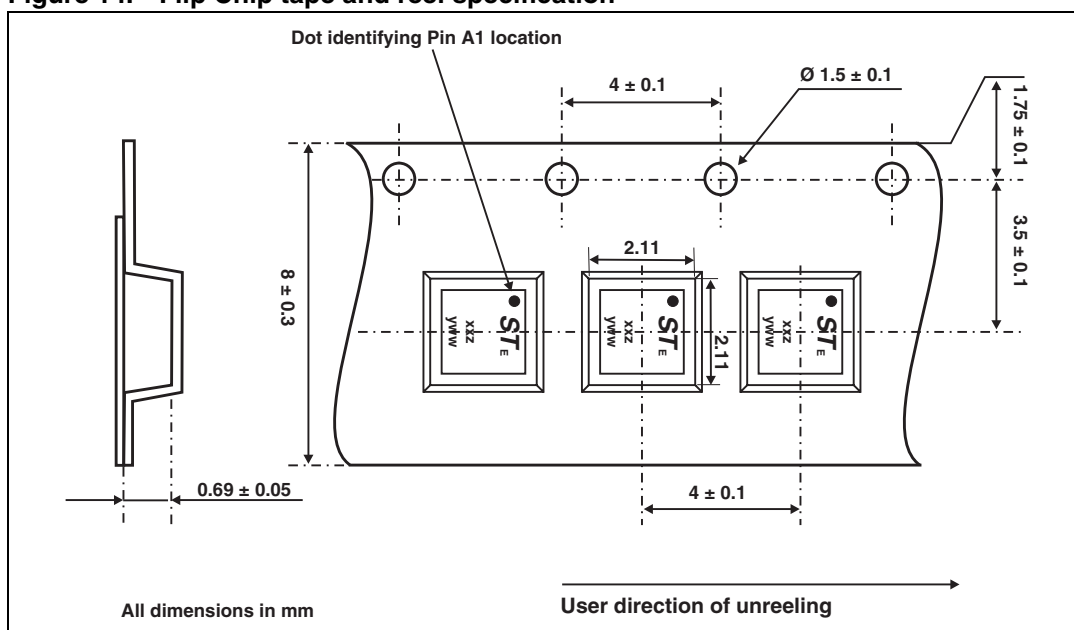


Figure 14. Flip Chip tape and reel specification



Note: More information is available in the application notes:
 N2348: "STMicroelectronics 400 micro-metre Flip Chip: Package description and recommendation for use"
 AN1751: "EMI Filters: Recommendations and measurements"

5 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF10-LCD02F3	GY	Flip Chip	5.0 mg	5000	Tape and reel 7"

6 Revision history

Table 4. Document revision history

Date	Revision	Changes
11-Jul-2005	1	First issue.
28-Apr-2008	2	Updated ECOPACK statement. Updated Figure 10 , Figure 11 , Figure 12 and Figure 14 . Reformatted to current standards.

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